

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	14	(automotive or automobile or car) same (rectifier) same (ac or alternating near current) near2 generat\$4 and (diode or zener) near8 (lead or leadframe or bonding near wire or wirebond\$3 or electrode) and (diode or zener) near6 (solder\$3)	US-PGPUB; USPAT; DERWENT	OR	ON	2006/02/14 15:29
L2	583	257/675.ccls.	US-PGPUB; USPAT; DERWENT	OR	ON	2006/02/14 16:31
L4	187	257/708.ccls.	US-PGPUB; USPAT; DERWENT	OR	ON	2006/02/14 16:44
L6	1485	257/712.ccls.	US-PGPUB; USPAT; DERWENT	OR	ON	2006/02/14 16:55
L7	128	257/712.ccls. and (copper near molybdenum or copper near tungsten or cumo or cu near mo or cuw or cu near w)	US-PGPUB; USPAT; DERWENT	OR	ON	2006/02/14 17:11
L8	261	257/729.ccls.	US-PGPUB; USPAT; DERWENT	OR	ON	2006/02/14 16:57
L12	1444	310/68R.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/14 17:10
L13	1	310/68R.ccls. and (copper near molybdenum or copper near tungsten or cumo or cu near mo or cuw or cu near w)	US-PGPUB; USPAT; DERWENT	OR	ON	2006/02/14 17:12
L14	61	148/679.ccls.	US-PGPUB; USPAT; DERWENT	OR	ON	2006/02/14 17:12
S1	87	(diode or led) near4 (base or cup or package or leadframe or lead or bowl) and (base or cup or package or leadframe or lead or bowl) near10 (cumo or cu-mo or cu near mo or copper near molybdenum or cuw or cu near w or copper near tungsten or cu-w)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/06 12:48

S2	1235	(diode or led) near4 (base or cup or package or leadframe or lead or bowl) and (base or cup or package or leadframe or lead or bowl) near10 (punch or counter-punch or punching or extrusion or extruding or compression or pressing)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/09 13:18
S3	37	(diode or led) near4 (base or cup or package or leadframe or lead or bowl) and (base or cup or package or leadframe or lead or bowl) near10 (punch or counter-punch or punching or extrusion or extruding or compression or pressing) near10 (copper or cu or cu-mo or cu-w)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/09 13:18
S4	2	(diode or led) near4 (base or cup or package or leadframe or lead or bowl) and (plastic near working or cold near extrusion or cold near extruding or cold near forging or counter near punch\$3) near10 (copper near alloy or cumo or cu-mo or cu near mo or copper near molybdenum or cuw or cu near w or copper near tungsten or cu-w)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/06 09:23
S5	336	(base or cup or package or leadframe or lead or bowl) and (plastic near working or cold near extrusion or cold near extruding or cold near forging or counter near punch\$3) and (copper near alloy or cumo or cu-mo or cu near mo or copper near molybdenum or cuw or cu near w or copper near tungsten or cu-w)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/06 09:23
S6	65	(base or cup or package or leadframe or lead or bowl) and (plastic near working or cold near extrusion or cold near extruding or cold near forging or counter near punch\$3) same (copper near alloy or cumo or cu-mo or cu near mo or copper near molybdenum or cuw or cu near w or copper near tungsten or cu-w)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/06 09:23
S7	30	(cold near compact\$3 or plastic near2 (molding or deform\$5) or impression near die near2 (stamp\$3 or forging or forged) or punch near press or punch near pressing or cold near extrusion or cold near extrud\$3 or plastic near working or cold near forging or counter near punch\$3) near10 (cumo or cu-mo or cu near3 mo or copper near molybdenum or cuw or cu near3 w or copper near tungsten or cu-w)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/06 13:47

S8	156	(compact\$3 or plastic near2 (molding or deform\$5) or impression near2 (stamp\$3 or forging or forged) or punch near press or punch near pressing or extrusion or extrud\$3 or plastic near working or forging or counter near punch\$3) near20 (cumo or cu-mo or cu near3 mo or copper near molybdenum or cuw or cu near3 w or copper near tungsten or cu-w) and (package or semiconductor or device or housing or diode or leadframe or lead near frame)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/06 13:50
S9	18	(US-20010022869-\$ or US-20010038140-\$ or US-20020017346-\$ or US-20020191377-\$ or US-20030224554-\$ or US-20040234412-\$ or US-20040264886-\$ or US-20050029535-\$ or US-20050029666-\$ or US-20050072981-\$ or US-20050174544-\$ or US-20050285505-\$).did. or (US-3903784-\$ or US-6040757-\$ or US-6398372-\$ or US-6405762-\$ or US-6538367-\$).did. or (JP-2000294668-\$).did.	US-PGPUB; USPAT; DERWENT	OR	ON	2006/02/13 14:01
S10	312	(automotive or automobile or car) same (rectifier) same (ac or alternating near current) near2 generat\$4	US-PGPUB; USPAT; DERWENT	OR	ON	2006/02/13 15:49
S11	55	(automotive or automobile or car) same (rectifier) same (ac or alternating near current) near2 generat\$4 and (diode or semiconductor or chip) near4 (cup or base or leadframe or frame or bowl or holder or carrier or lead)	US-PGPUB; USPAT; DERWENT	OR	ON	2006/02/13 14:54
S12	13	(automotive or automobile or car) same (rectifier) same (ac or alternating near current) near2 generat\$4 and (cup or base or leadframe or frame or bowl or holder or carrier or lead) near10 (copper or cumo or cuw or cu near mo or cu near w)	US-PGPUB; USPAT; DERWENT	OR	ON	2006/02/13 15:41

S13	1	(copper near alloy or copper near molybdenum or copper near tungsten or cumo or cu near mo or cuw or cu near w) near8 (extruding or extruded or extrusion or cold near forging or counter near punch or counter near punching or counter near punched or punch\$3 near5 female or plastic near working) same (diode)	US-PGPUB; USPAT; DERWENT	OR	ON	2006/02/13 15:44
S14	38	(copper near alloy or copper near molybdenum or copper near tungsten or cumo or cu near mo or cuw or cu near w) near8 (extruding or extruded or extrusion or cold near forging or counter near punch or counter near punching or counter near punched or punch\$3 near5 female or plastic near working) same (package or housing or base or cup or bowl or support or leadframe or lead adj frame or mounting)	US-PGPUB; USPAT; DERWENT	OR	ON	2006/02/13 15:47
S15	2	(automotive or automobile or car) same (rectifier) same (ac or alternating near current) near2 generat\$4 and (copper near molybdenum or cumo or cu near mo or copper near tungsten or cuw or cu near w)	US-PGPUB; USPAT; DERWENT	OR	ON	2006/02/14 14:42